

NP109N04PUK

MOS FIELD EFFECT TRANSISTOR

R07DS0544EJ0200 Rev. 2.00 May 24, 2018

Description

NP109N04TUK is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

- · Super low on-state resistance
 - $R_{DS(on)}$ = 1.75 m Ω MAX. (V_{GS} = 10 V, I_D = 55 A)
- · Low Ciss Ciss = 7200 pF TYP. (V_{DS} = 25 V)
- · Designed for automotive application and AEC-Q101 qualified

Ordering Information

Part No.	Lead Plating	Pac	Package	
NP109N04PUK-E1-AY *1	Pure Sn (Tin)	Tape 800 p/reel	Taping (E1 type)	TO-263(MP-25ZP)
NP109N04PUK-E2-AY *1			Taping (E2 type)	

Note: *1. Pb-free (This product does not contain Pb in the external electrode.)

Absolute Maximum Ratings (T_A=25°C)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	40	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (T _C = 25 °C)	I _{D(DC)}	±110	Α
Drain Current (pulse) *1, 3	I _{D(pulse)}	±440	Α
Total Power Dissipation (T _C = 25 °C)	P _{T1}	250	W
Total Power Dissipation (T _A = 25 °C)	P _{T2}	1.8	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	-55 to 175	°C
Repetitive Avalanche Current *2,3	lar	56	Α
Repetitive Avalanche Energy *2, 3	Ear	313	mJ

Thermal Resistance

Channel to Case Thermal Resistance	Rth(ch-C)*3	0.60	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)*3	83.3	°C/W

Notes *1. TC = 25°C, PW \leq 10 μ s, Duty Cycle \leq 1%

*2. RG = 25 Ω , VGS = 20 \rightarrow 0 V

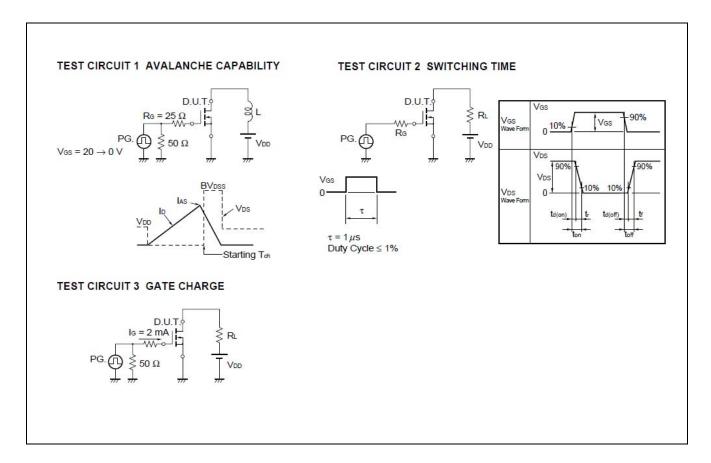
*3. Not subject of production test. Verified by design/characterization.

Electrical Characteristics (T_A=25°C)

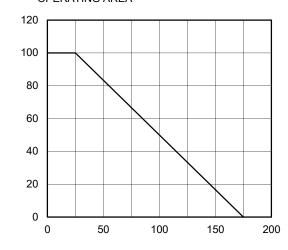
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	V _{DS} = 40 V, V _{GS} = 0 V
Gate Leakage Current	I _{GSS}			±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	V _{DS} = V _{GS} , I _D = 250 μA
Forward Transfer Admittance *1	y _{fs}	50	100		S	V _{DS} = 5 V, I _D = 55 A
Drain to Source On-state	R _{DS(on)}		1.40	1.75	mΩ	V _G S = 10 V, I _D = 55 A
Resistance *1						
Input Capacitance *2	C _{iss}		7200	10800	pF	V _{DS} = 25 V
Output Capacitance *2	C _{oss}		1040	1560	pF	V _{GS} = 0 V
Reverse Transfer Capacitance *2	C _{rss}		390	710	pF	f = 1 MHz
Turn-on Delay Time *2	t _{d(on)}		30	70	ns	V _{DD} = 20 V, I _D = 55 A
Rise Time *2	t _r		16	40	ns	V _{GS} = 10 V
Turn-off Delay Time *2	t _{d(off)}		105	210	ns	$R_G = 0 \Omega$
Fall Time *2	t _f		13	40	ns	
Total Gate Charge *2	Q_{G}		126	189	nC	V _{DD} = 32 V
Gate to Source Charge	Q _{GS}		32		nC	V _G s = 10 V
Gate to Drain Charge	Q_{GD}		31		nC	I _D = 110 A
Body Diode Forward Voltage *1	$V_{F(S-D)}$		0.9	1.5	V	I _F = 110 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}		62		ns	I _F = 110 A, V _{GS} = 0 V
Reverse Recovery Charge	Q _{rr}		110		nC	di/dt = 100 A/μs

Note. *1 Pulse test

Note. *2 Not subject of production test. Verified by design/characterization.

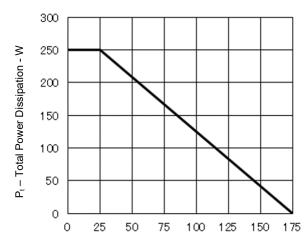


DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



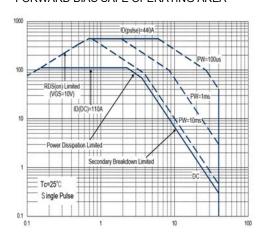
 T_{C} - Case Temperature - $^{\circ}\text{C}$

TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



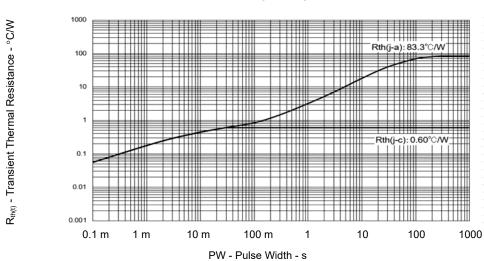
T_C - Case Temperature - °C

FORWARD BIAS SAFE OPERATING AREA



 $V_{\text{\scriptsize DS}}$ - Drain to Source Voltage – V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

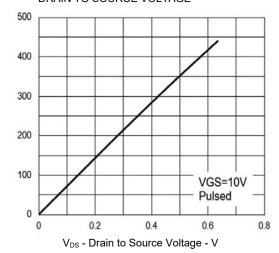


Ip - Drain Current - A

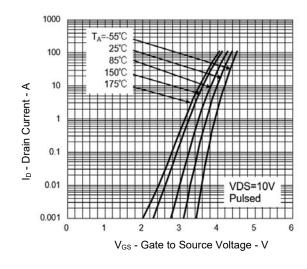
V_{GS(th)} - Gate to Source Threshold Voltage - V

 $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$

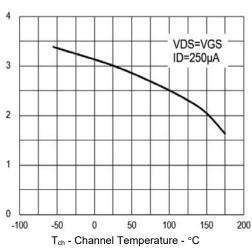
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



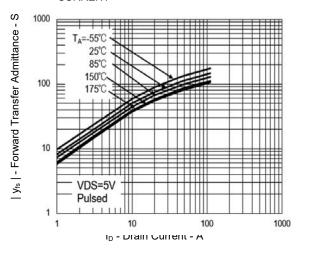
FORWARD TRANSFER CHARACTERISTICS



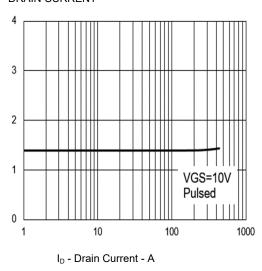
GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



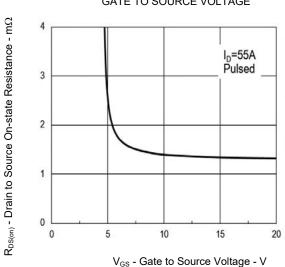
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



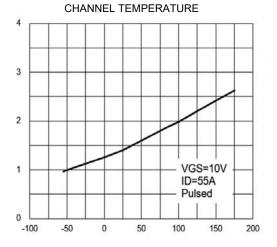
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs.



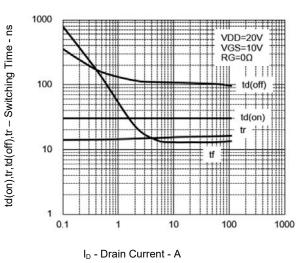
T_{ch} - Channel Temperature - °C

100000 Ciss : 10000 VGS=0V Crss f=1MHz 100 100

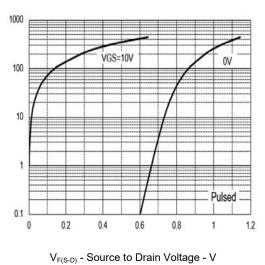
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

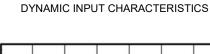
V_{DS} - Drain to Source Voltage - V

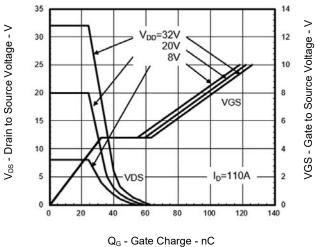
SWITCHING CHARACTERISTICS



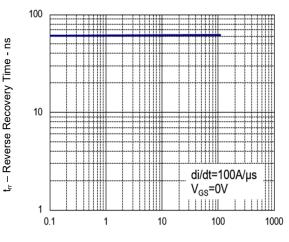
SOURCE TO DRAIN DIODE FORWARD VOLTAGE







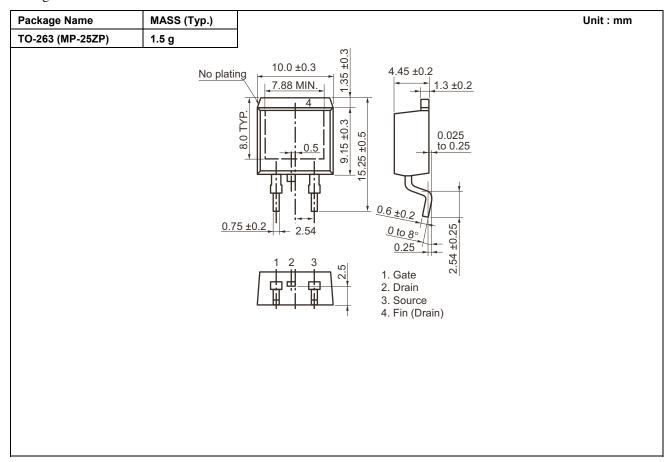
REVERSE RECOVERY TIME vs.
DRAIN CURRENT

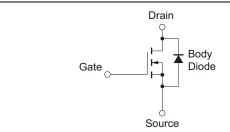


I_F - Drain Current - A

IF - Diode Forward Current - A

Package Dimensions





Equivalent circuit

Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Revision History

NP180N04TUK Preliminary Datasheet

		Description		
Rev.	Date	Page	Summary	
0.01	Apr 26, 2010	-	1st edition	
2.00	May 24 ,2018	1	Note 3 was added	
		2	Note 2 was added	

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